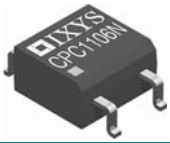
IXYS
INTEGRATED CIRCUITS DIVISION



CPC1106N
Single-Pole, Normally Closed 4-Lead SOP OptoMOS® Relay

Parameter	Rating	Units
Blocking Voltage	60	V_P
Load Current	75	mA_{rms} / mA_{DC}
On-Resistance (max)	10	Ω
LED Current to Operate	0.5	mA

Features
- Designed for EN50130-4 Compliant Security Systems
- Only 0.5mA of LED Current Required to Operate
- 1500V_{rms} Input/Output Isolation
- Small 4-Lead SOP Package
- TTL/CMOS Compatible Input
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to Radiated EM Fields
- SMD Pick & Place, Wave Solderable
- Tape & Reel Version Available

Applications
- Security
  - Passive Infrared Detectors (PIR)
  - Data Signalling
  - Sensor Circuitry
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description
The CPC1106N is a miniature, single-pole, normally closed (1-Form-B) solid state relay in a 4-lead SOP package that employs optically coupled MOSFET technology to provide 1500V_{rms} of input to output isolation.

The relay outputs are constructed with efficient MOSFET switches and photovoltaic die that use IXYS Integrated Circuits Division's patented OptoMOS architecture while the input, a highly efficient GaAlAs infrared LED, provides the optically coupled control.

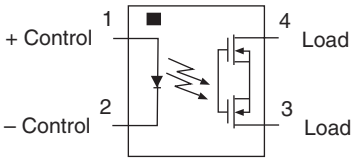
The CPC1106N, using IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging to produce one of the world's smallest relays, offers board space savings of at least 20% over the competitor's larger 4-lead SOP relay.

Approvals
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

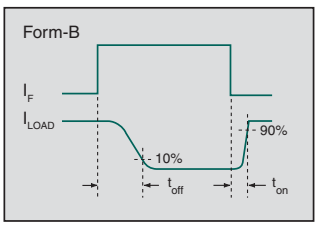
Ordering Information

Part #	Description
CPC1106N	4-Lead SOP (100/tube)
CPC1106NTR	4-Lead SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally Closed Devices



Absolute Maximum Ratings @ 25ºC

Parameter	Ratings	Units
Blocking Voltage	60	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Disipation	70	mW
Total Power Dissipation [1]	400	mW
Isolation Voltage, Input to Output	1500	V_{rms}
ESD Rating, Human Body Model	8	kV
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

[1] Derate linearly 3.33 mW / ºC

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

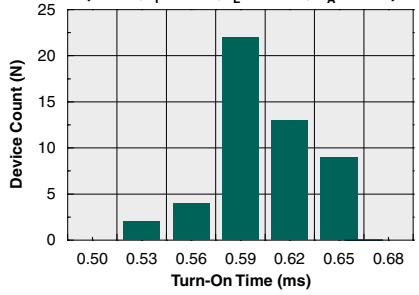
Electrical Characteristics @ 25ºC

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous	I_F=0mA	I_L	-	-	75	mA_{rms} / mA_{DC}
Peak	t=10ms	I_{LPK}	-	-	±350	mA_P
On-Resistance [1]	I_F=0mA, I_L=75mA	R_{ON}	-	3.85	10	Ω
Off-State Leakage Current	I_F=0.5mA, V_L=60V_P	I_{LEAK}	-	-	1	µA
Switching Speeds						
Turn-On	I_F=2mA, V_L=10V	t_{on}	-	-	10	ms
Turn-Off		t_{off}	-	-	10	
Output Capacitance	I_F=0.5mA, V_L=50V, f=1MHz	C_{OUT}	-	10	-	pF
Input Characteristics						
Input Control Current to Activate [2]	-	I_F	-	0.16	0.5	mA
Input Control Current to Deactivate	I_L=75mA	I_F	0.05	-	-	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.4	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Capacitance, Input to Output	-	-	-	1	-	pF

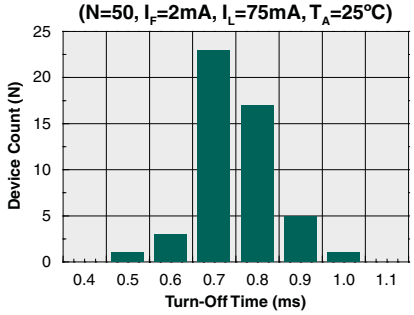
[1] Measurement taken within 1 second of on-time.
[2] For applications requiring high temperature operation (greater than 60ºC) a LED drive current of 2mA is recommended.

PERFORMANCE DATA*

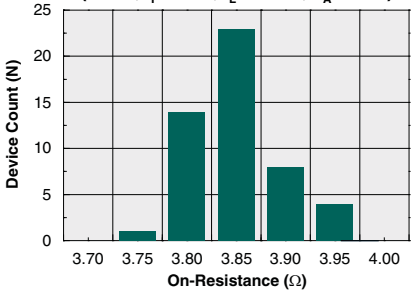
Typical Turn-On Time
(N=50, I_F=2mA, I_L=75mA, T_A=25°C)



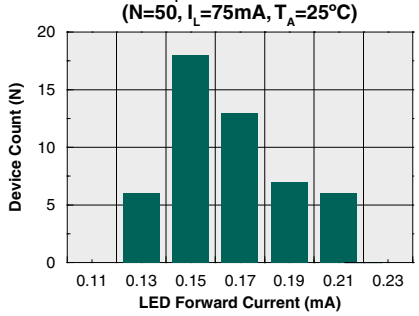
Typical Turn-Off Time
(N=50, I_F=2mA, I_L=75mA, T_A=25°C)



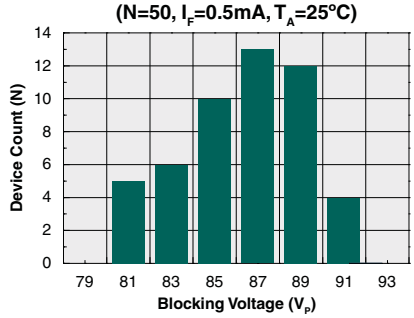
Typical On-Resistance Distribution
(N=50, I_F=0mA, I_L=75mA, T_A=25°C)



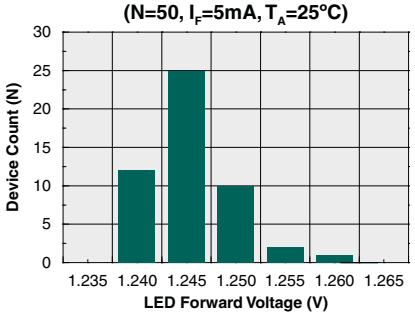
Typical I_F for Switch Operation
(N=50, I_L=75mA, T_A=25°C)



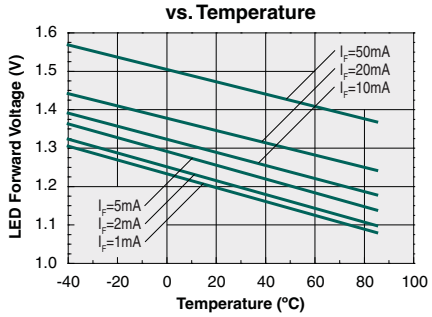
Typical Blocking Voltage Distribution
(N=50, I_F=0.5mA, T_A=25°C)



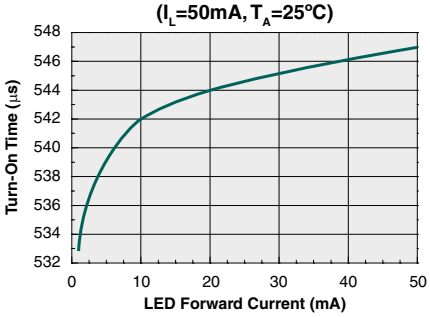
Typical LED Forward Voltage Drop
(N=50, I_F=5mA, T_A=25°C)



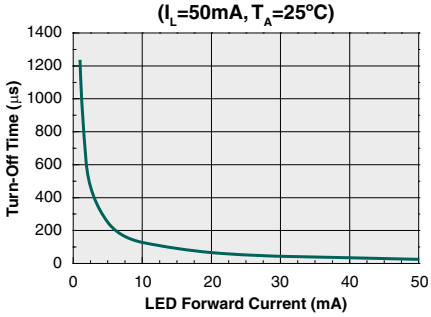
Typical LED Forward Voltage Drop
vs. Temperature



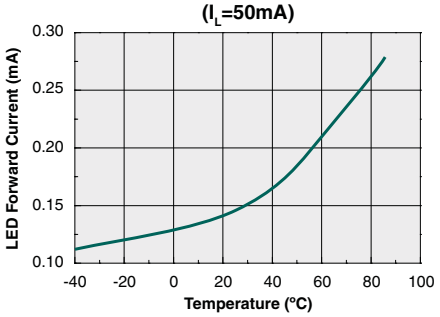
Typical Turn-On Time
vs. LED Forward Current
(I_L=50mA, T_A=25°C)



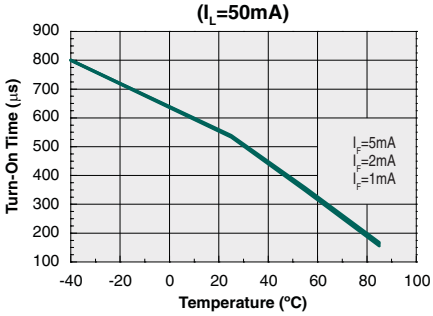
Typical Turn-Off Time
vs. LED Forward Current
(I_L=50mA, T_A=25°C)



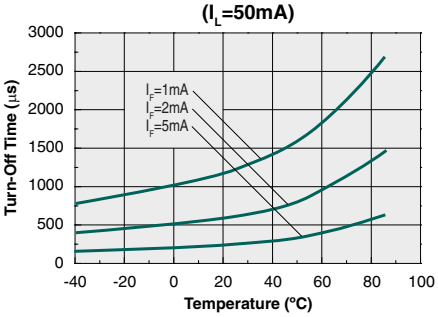
Typical I_F for Switch Operation
vs. Temperature
(I_L=50mA)



Typical Turn-On Time
vs. Temperature
(I_L=50mA)



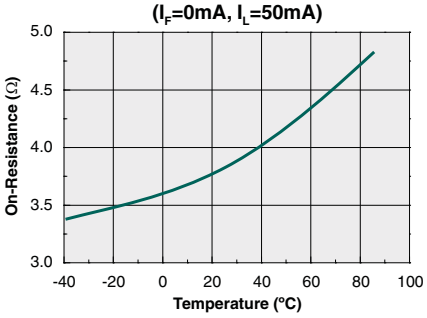
Typical Turn-Off Time
vs. Temperature
(I_L=50mA)



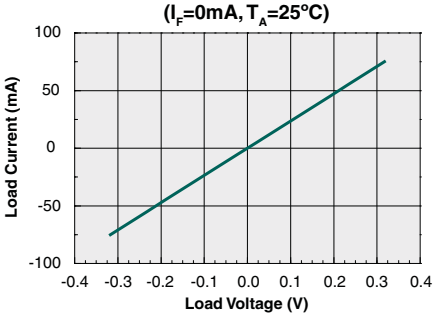
*The Performance Data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

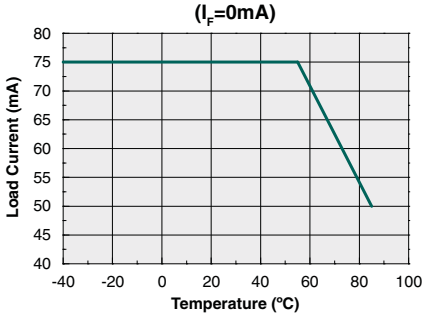
Typical On-Resistance vs. Temperature (I_F=0mA, I_L=50mA)



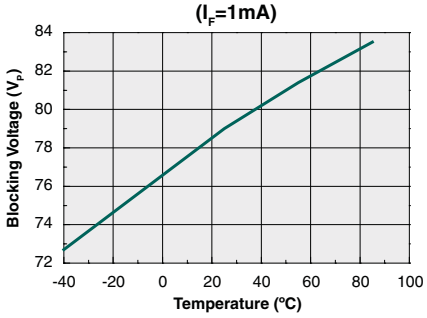
Typical Load Current vs. Load Voltage (I_F=0mA, T_A=25°C)



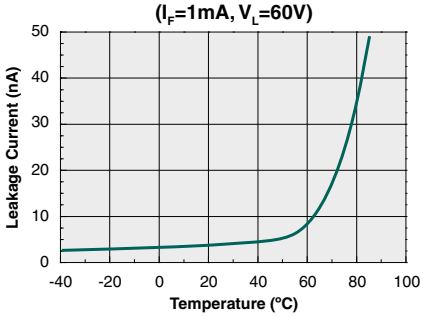
Maximum Load Current vs. Temperature (I_F=0mA)



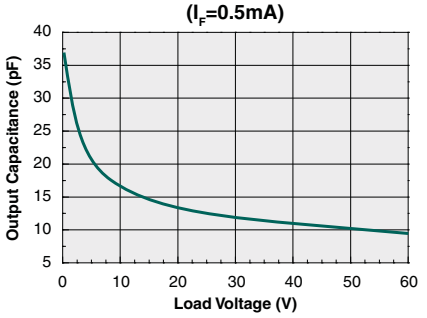
Typical Blocking Voltage vs. Temperature (I_F=1mA)



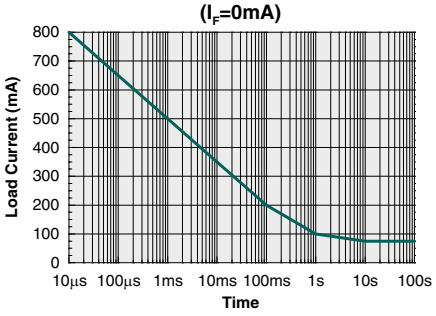
Typical Leakage vs. Temperature Measured Across Pins 3&4 (I_F=1mA, V_L=60V)



Output Capacitance vs. Load Voltage (I_F=0.5mA)



Energy Rating Curve (I_F=0mA)



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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1106N	MSL 3

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

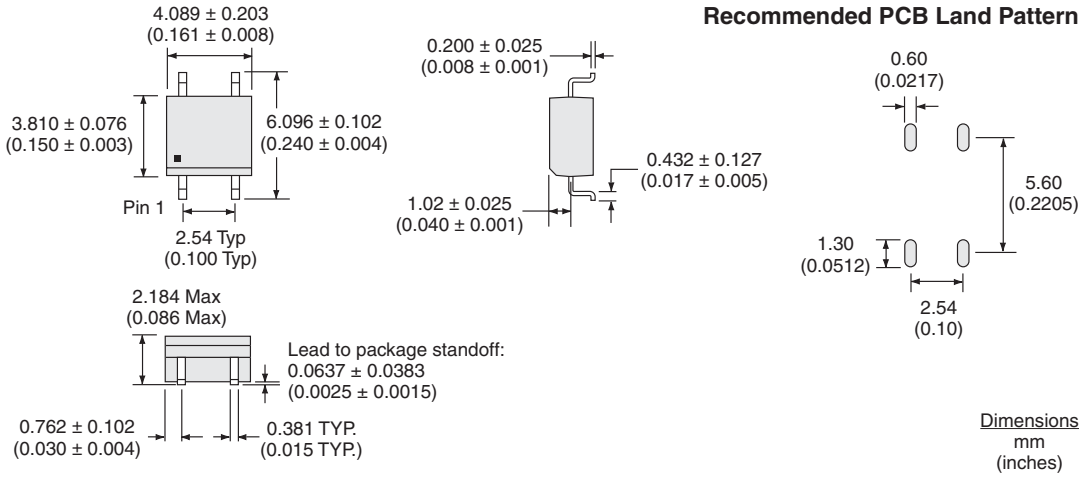
Device	Maximum Temperature x Time
CPC1106N	260°C for 30 seconds

Board Wash

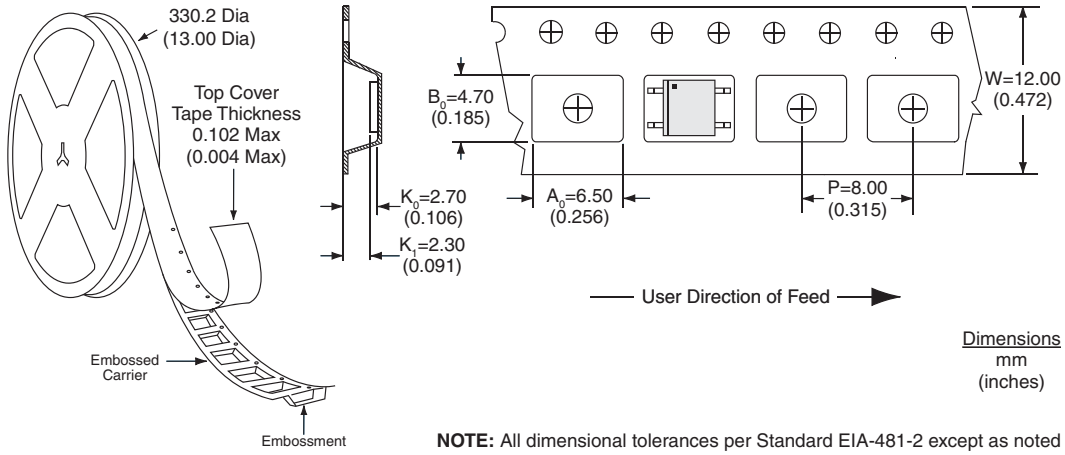
IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

Mechanical Dimensions

CPC1106N



CPC1106NTR Tape & Reel



NOTE: All dimensional tolerances per Standard EIA-481-2 except as noted

For additional information please visit our website at: www.ixysic.com

Specification: DS-CPC1106N-R03

12/14/2012

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